DATA SHEET

GENERAL DESCRIPTION

The 843023 is a Gigabit Ethernet Clock Generator and a member of the HiPerClocks™ family of high performance devices from IDT. The 843023 uses a 25MHz crystal to synthesize 250MHz. The 843023 has excellent phase jitter performance, over the 1.875MHz − 20MHz integration range. The 843023 is packaged in a small 8-pin TSSOP, making it ideal for use in systems with limited board space.

FEATURES

- One differential 3.3V LVPECL output
- Crystal oscillator interface designed for 25MHz, 18pF parallel resonant crystal
- Output frequencies: 245MHz 320MHz
- VCO range: 490MHz 640MHz
- RMS phase jitter @ 250MHz, using a 25MHz crystal (1.875MHz - 20MHz): 0.39ps (typical)

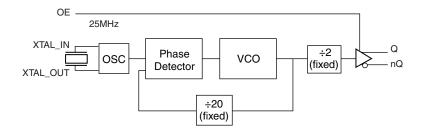
Offset	Noise Power
100Hz	86.3 dBc/Hz
1kHz	114.6 dBc/Hz
10kHz	125.6 dBc/Hz
100kHz	126 dBc/Hz

· 3.3V operating supply

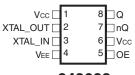
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- 0°C to 70°C ambient operating temperature
- Available in lead-free (RoHS 6) package

BLOCK DIAGRAM



PIN ASSIGNMENT



843023

8-Lead TSSOP 4.40mm x 3.0mm x 0.925mm package body G Package Top View



TABLE 1. PIN DESCRIPTIONS

Number	Name	Ту	ре	Description
1, 6	V _{cc}	Power		Positive supply pin.
2, 3	XTAL_OUT, XTAL_IN	Input		Crystal oscillator interface. XTAL_IN is the input, XTAL_OUT is the output.
4	V _{EE}	Power		Negative supply pin.
5	OE	Input	Pullup	Active high output enable. When logic HIGH, the outputs are enabled and active. When logic LOW, the outputs are disabled and the device is in the power down mode. LVCMOS/LVTTL interface levels.
7, 8	nQ, Q	Output		Differential clock outputs. LVPECL interface levels.

Pullup refers to internal input resistors. See Table 2, Pin Characteristics, for typical values.

Table 2. Pin Characteristics

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C	Input Capacitance			4		pF
R	Input Pullup Resistor			51		kΩ



ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{cc} 4.6V

Inputs, V_{cc} -0.5V to V_{cc} + 0.5V

Outputs, I

Continuous Current 50mA Surge Current 100mA

Package Thermal Impedance, $\theta_{\text{\tiny IA}}$ 101.7°C/W (0 mps)

Storage Temperature, T_{stg} -65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Table 3A. Power Supply DC Characteristics, $V_{cc} = 3.3V \pm 5\%$, Ta=0°C to 70°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{cc}	Positive Supply Voltage		3.135	3.3	3.465	V
V _{CCA}	Analog Supply Voltage		3.135	3.3	3.465	V
I _{EE}	Power Supply Current				75	mA

Table 4B. LVCMOS/LVTTL DC Characteristics, $V_{cc} = 3.3V \pm 5\%$, $T_A = 0^{\circ}C$ to $70^{\circ}C$

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V _{IH}	Input High Voltage			2		V _{cc} + 0.3	V
V	Input Low Voltage			-0.3		0.8	V
I _{IH}	Input High Current	OE	V _{CC} = V _{IN} = 3.465V			5	μΑ
I _u	Input Low Current	OE	$V_{CC} = 3.465V, V_{IN} = 0V$	-150			μΑ

Table 3C. LVPECL DC Characteristics, $V_{cc} = 3.3V \pm 5\%$, Ta=0°C to 70°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{OH}	Output High Voltage; NOTE 1		V _{cc} - 1.4		V _{cc} - 0.9	V
V _{oL}	Output Low Voltage; NOTE 1		V _{cc} - 2.0		V _{cc} - 1.7	V
V _{SWING}	Peak-to-Peak Output Voltage Swing		0.6		1.0	V

NOTE 1: Outputs terminated with 50Ω to V_{cc} - 2V.

TABLE 4. CRYSTAL CHARACTERISTICS

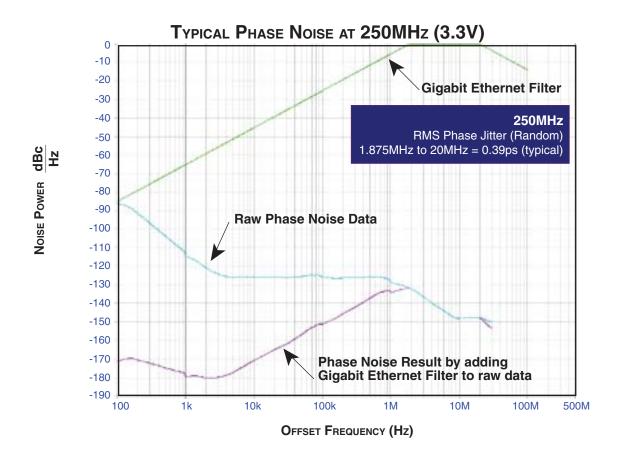
Parameter	Test Conditions	Minimum	Typical	Maximum	Units
Mode of Oscillation		Fundamental			
Frequency		24.5		32	MHz
Equivalent Series Resistance (ESR)				50	Ω
Shunt Capacitance				7	pF
Drive Level				1	mW

Table 5. AC Characteristics, $V_{cc} = 3.3V \pm 5\%$, Ta=0°C to 70°C

Symbol	nbol Parameter Test Conditions		Minimum	Typical	Maximum	Units
f _{OUT}	Output Frequency		245		320	MHz
tjit(Ø)	RMS Phase Jitter (Random); NOTE 1	Integration Range: 1.875MHz - 20MHz		0.39		ps
t _R / t _F	Output Rise/Fall Time	20% to 80%	300		600	ps
odc	Output Duty Cycle		47		53	%

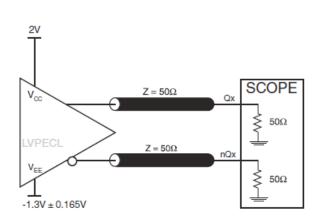
NOTE 1: Please refer to the Phase Noise Plot.

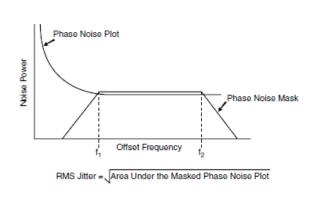






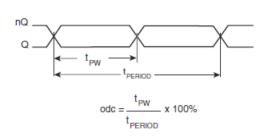
PARAMETER MEASUREMENT INFORMATION

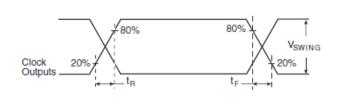




3.3V OUTPUT LOAD AC TEST CIRCUIT

RMS PHASE JITTER





OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD

OUTPUT RISE/FALL TIME



APPLICATION INFORMATION

CRYSTAL INPUT INTERFACE

The 843023 has been characterized with 18pF parallel resonant crystals. The capacitor values, C1 and C2, shown in *Figure 1* below were determined using a 25MHz, 18pF parallel

resonant crystal and were chosen to minimize the ppm error. The optimum C1 and C2 values can be slightly adjusted for different board layouts.

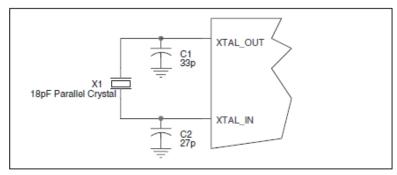


FIGURE 1. CRYSTAL INPUT INTERFACE

LVCMOS TO XTAL INTERFACE

The XTAL_IN input can accept a single-ended LVCMOS signal through an AC coupling capacitor. A general interface diagram is shown in *Figure 2* The XTAL_OUT pin can be left floating. The input edge rate can be as slow as 10ns. For LVCMOS inputs, it is recommended that the amplitude be reduced from full swing to half swing in order to prevent signal interference with the power rail and to reduce noise. This configuration requires that the output

impedance of the driver (Ro) plus the series resistance (Rs) equals the transmission line impedance. In addition, matched termination at the crystal input will attenuate the signal in half. This can be done in one of two ways. First, R1 and R2 in parallel should equal the transmission line impedance. For most 50Ω applications, R1 and R2 can be 100Ω . This can also be accomplished by removing R1 and making R2 50Ω .

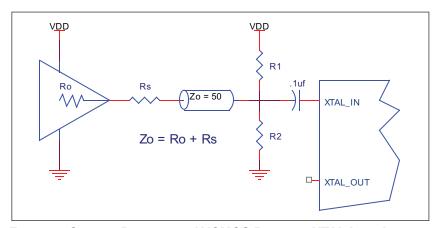


FIGURE 2. GENERAL DIAGRAM FOR LVCMOS DRIVER TO XTAL INPUT INTERFACE



TERMINATION FOR 3.3V LVPECL OUTPUT

The clock layout topology shown below is a typical termination for LVPECL outputs. The two different layouts mentioned are recommended only as guidelines.

FOUT and nFOUT are low impedance follower outputs that generate ECL/LVPECL compatible outputs. Therefore, terminating resistors (DC current path to ground) or current sources must be used for functionality. These outputs are designed to drive 50Ω transmission

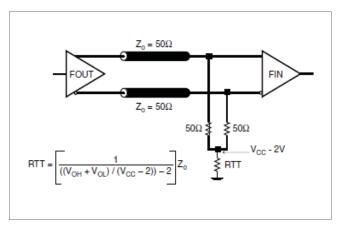


FIGURE 3A. LVPECL OUTPUT TERMINATION

lines. Matched impedance techniques should be used to maximize operating frequency and minimize signal distortion. *Figures 3A and 3B* show two different layouts which are recommended only as guidelines. Other suitable clock layouts may exist and it would be recommended that the board designers simulate to guarantee compatibility across all printed circuit and clock component process variations.

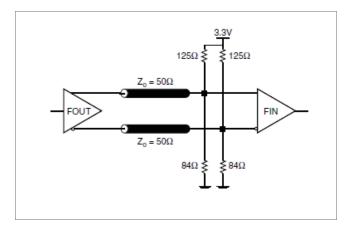


FIGURE 3B. LVPECL OUTPUT TERMINATION



Power Considerations

This section provides information on power dissipation and junction temperature for the 843023. Equations and example calculations are also provided.

1. Power Dissipation.

The total power dissipation for the 843023 is the sum of the core power plus the power dissipated in the load(s).

The following is the power dissipation for $V_{cc} = 3.3V + 5\% = 3.465V$, which gives worst case results.

NOTE: Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)_{MAX} = V_{CC_MAX} * I_{EE_MAX} = 3.465V * 75mA = 259.87mW
- Power (outputs)_{MAX} = 30mW/Loaded Output pair

Total Power $_{\text{max}}$ (3.465V, with all outputs switching) = 259.87mW + 30mW = 289.87mW

2. Junction Temperature.

Junction temperature, Tj, is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS[™] devices is 125°C.

The equation for Tj is as follows: Tj = θ_{JA} * Pd_total + T_A

Tj = Junction Temperature

 θ_{JA} = Junction-to-Ambient Thermal Resistance

Pd_total = Total Device Power Dissipation (example calculation is in section 1 above)

T_A = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance $\theta_{\rm JA}$ must be used. Assuming a moderate air flow of 1 meter per second and a multi-layer board, the appropriate value is 90.5°C/W per Table 6 below.

Therefore, Tj for an ambient temperature of 70°C with all outputs switching is:

 $70^{\circ}\text{C} + 0.290\text{W} * 90.5^{\circ}\text{C/W} = 96.2^{\circ}\text{C}$. This is well below the limit of 125°C.

This calculation is only an example. Tj will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

Table 6. Thermal Resistance θ_{JA} for 8-pin TSSOP, Forced Convection

$\theta_{\sf JA}$ by Velocity (Meters per Second)						
	0	1	2.5			
Multi-Layer PCB, JEDEC Standard Test Boards	101.7°C/W	90.5°C/W	89.8°C/W			



3. Calculations and Equations.

The purpose of this section is to derive the power dissipated into the load.

LVPECL output driver circuit and termination are shown in Figure 4.

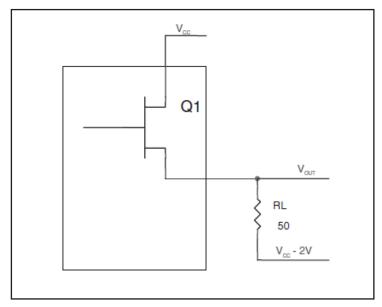


FIGURE 4. LVPECL DRIVER CIRCUIT AND TERMINATION

To calculate worst case power dissipation into the load, use the following equations which assume a 50Ω load, and a termination voltage of V_{cc}^{-} 2V.

• For logic high,
$$V_{OUT} = V_{OH MAX} = V_{CC MAX} - 0.9V$$

$$(V_{CC_MAX} - V_{OH_MAX}) = 0.9V$$

• For logic low, $V_{OUT} = V_{OL_MAX} = V_{CC_MAX} - 1.7V$

$$(V_{CC MAX} - V_{OL MAX}) = 1.7V$$

Pd_H is power dissipation when the output drives high.

Pd_L is the power dissipation when the output drives low.

$$Pd_H = [(V_{\text{OH_MAX}} - (V_{\text{CC_MAX}} - 2V))/R_{_{L}}] * (V_{\text{CC_MAX}} - V_{\text{OH_MAX}}) = [(2V - (V_{\text{CC_MAX}} - V_{\text{OH_MAX}}))/R_{_{L}}] * (V_{\text{CC_MAX}} - V_{\text{OH_MAX}}) = [(2V - 0.9V)/50\Omega] * 0.9V = 19.8mW$$

$$Pd_L = [(V_{OL_MAX} - (V_{CC_MAX} - 2V))/R_{L}] * (V_{CC_MAX} - V_{OL_MAX}) = [(2V - (V_{CC_MAX} - V_{OL_MAX}))/R_{L}] * (V_{CC_MAX} - V_{OL_MAX}) = [(2V - 1.7V)/50\Omega] * 1.7V = 10.2mW$$

Total Power Dissipation per output pair = Pd_H + Pd_L = 30mW



RELIABILITY INFORMATION

Table 7. $\theta_{_{JA}}$ vs. Air Flow Table for 8 Lead TSSOP

 $\theta_{\mbox{\tiny JA}}$ by Velocity (Meters per Second)

1

2.5

Multi-Layer PCB, JEDEC Standard Test Boards

0 101.7°C/W

90.5°C/W

89.8°C/W

TRANSISTOR COUNT

The transistor count for 843023 is: 2360



PACKAGE OUTLINE - G SUFFIX FOR 8 LEAD TSSOP

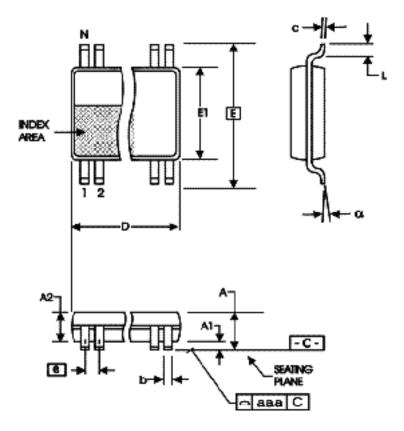


TABLE 8. PACKAGE DIMENSIONS

CVMDOL	Millin	neters
SYMBOL	Minimum	Maximum
N	8	3
A		1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
С	0.09	0.20
D	2.90	3.10
E	6.40 E	BASIC
E1	4.30	4.50
е	0.65 E	BASIC
L	0.45	0.75
α	0°	8°
aaa		0.10

Reference Document: JEDEC Publication 95, MO-153



TABLE 9. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
ICS843023AGLF	023AL	8 Lead "Lead-Free" TSSOP	tube	0°C to 70°C
ICS843023AGLFT	023AL	8 Lead "Lead-Free" TSSOP	tape & reel	0°C to 70°C

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

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REVISION HISTORY SHEET						
Rev	Table	Page	Description of Change	Date		
۸		6	Added LVCMOS to XTAL Interface.	12/22/06		
Α	Т9	12	Ordering Information Table - corrected temperature from -40 to 85°C to 0 to 70°C.	12/22/06		
Α		1	Features Section - corrected RMS Phase Jitter integration range.	2/14/08		
Α	Т9	12	Ordering Information - removed leaded devices. Added Lead Free marking. Updated data sheet format.	10/1/15		



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